

Features

- 0603 0.5mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S63DBS5R5UW is a dual-color 0603, 4pin package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

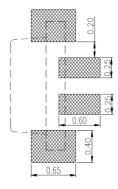
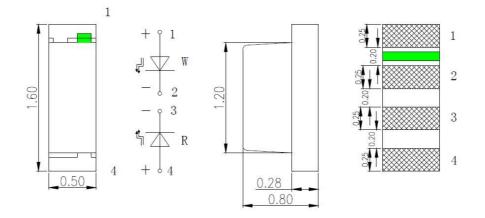


Figure 1. IN-S63DBS5R5UW Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-S63DBS5R5UW Package Dimensions



Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)
	Red	65		70			
IN-S63DBS5R5UW	White	90	25	90	5	-30°C~+85°C	-40°C~+90°C

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics TA = 25°C (Note 1)

			V _F (V)		λ (nm)			Viewing Angle	I [*] _V (mcd)
Product	Emission Color	I _F (mA)	typ.	max	λо	λР	Δλ	2 θ 1/2	typ.
IN CCORROS DELIM	Red	5	1.9	2.2	622	630	20	120	35
IN-S63DBS5R5UW	White	5	3.0	3.2	X=0.25 Y=0.22	-	-	120	200

Notes

1. Performance guaranteed only under conditions listed in above tables.



Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range			
	G2	23.0-28.5 mcd			
Red	H1	28.5-35.0 mcd			
neu	H2	35.0-45.0 mcd			
	J1	45.0-56.0 mcd			
	L2	180.0-230.0 mcd			
White	M1	230.0-285.0 mcd			
vvriite	M2	285.0-350.0 mcd			
	N1	350.0-450.0 mcd			

@5mA / Ta=25° C, Tolerance: ± 10%

Dominant Wavelength (λD) Bin:

Color	Bin Code	Spec. Range			
	Α	615-620			
Red	В	620-625			
	С	625-630			

@5mA / Ta=25° C, Tolerance: ± 0.5nm

Forward Voltage (Vf) Bin:

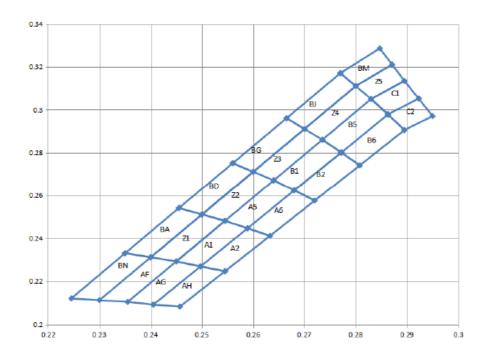
Color	Bin Code	Spec. Range		
	1	1.8-2.0		
Red	2	2.0-2.2		
	3	2.2-2.4		
	1	2.6-2.8		
White	2	2.8-3.0		
	3	3.0-3.2		

@5mA / Ta=25° C, Tolerance: ± 0.05V



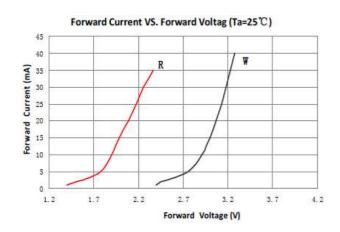
White Bin Range of Wavelength

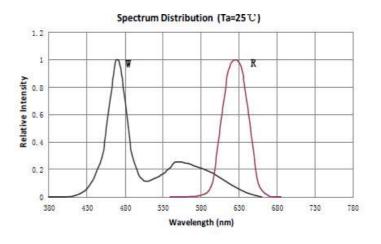
Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y
	0. 2245	0. 2118		0. 2300	0. 2110		0. 2355	0. 2102		0. 2405	0. 2089
BN	DAT 0. 2300 0. 21	0. 2110	AF	0. 2355	0. 2102	AG	0. 2405	0. 2089	AH	0. 2457	0. 2080
DN	0. 2400	0. 2310	AI	0. 2450	0. 2291	AU	0. 2497	0. 2267	AII	0. 2545	0. 2245
	0. 2350	0. 2329		0.2400	0. 2310		0. 2450	0. 2291		0.2497	0. 2267
	0. 2350	0. 2329		0.2400	0. 2310		0. 2497	0. 2267		0.2497	0. 2267
BA	0. 2400	0. 2310	Z1	0.2500	0. 2510	A1	0. 2450	0. 2290	A2	0.2589	0. 2445
DA	0. 2500	0. 2510	0. 2545 0. 2480	nı.	0. 2545	0.2480	n2	0.2633	0.2410		
	0. 2455	0. 2540		0.2450	0. 2291		0. 2589	0. 2445		0.2545	0. 2245
	0. 2455	0. 2540		0.2500	0.2510		0. 2545	0.2480		0. 2589	0.2445
BD	0. 2500	0. 2510	Z 2	0.2600	0. 2710	A5	0. 2589	0. 2445	A6	0.2633	0.2410
DD	0. 2600	0.2710		0.2640	0. 2670		0. 2680	0. 2623	NO.	0.2720	0. 2575
	0. 2560	0.2750		0. 2545	0. 2480		0. 2640	0.2670		0.2680	0.2623
	0. 2560	0.2750		0.2600	0.2710	B1	0. 2640	0.2670		0.2720	0. 2575
BG	0. 2600	0.2710	Z3	0.2700	0. 2910		0. 2680	0. 2623	B2	0.2680	0. 2623
20	0. 2700	0.2910		0.2735	0. 2860		0. 2772	0.2800		0.2772	0.2800
	0. 2665	0. 2960		0.2640	0. 2670		0. 2735	0. 2860		0.2808	0.2740
	0. 2665	0.2960		0. 27	0. 291		0. 2735	0.2860		0.2772	0.2800
ВЛ	0. 2700	0.2910	Z4	0. 28	0.311	B5	0. 2772	0.2800	В6	0. 2808	0.2740
25	0. 2800	0.3110		0.283	0.305		0. 2863	0. 2978		0. 2895	0.2905
	0. 2770	0.3170		0.2735	0. 286		0. 2830	0.3050		0.2863	0.2978
	0. 2770	0.3170		0. 28	0.311		0. 2830	0.3050		0.2863	0.2978
BM	0. 2800	0.3110	Z5	0. 2871	0.321	C1	0.2863	0. 2978	C2	0.2895	0.2905
2011	0. 2871	0.3210	20	0. 2895	0.3134		0. 2923	0.3052	- 02	0.2950	0.2970
	0. 2847	0.3286		0.283	0.305		0. 2895	0.3134		0.2923	0.3052

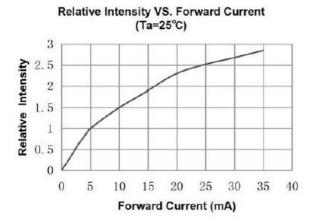


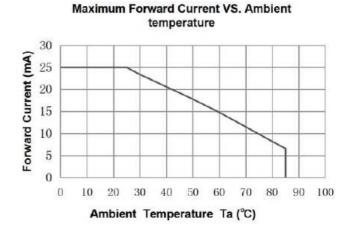


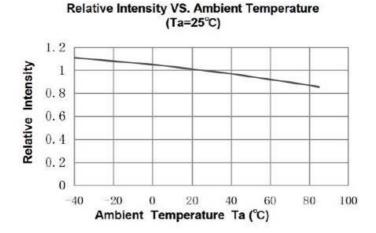
Typical Characteristic Curves





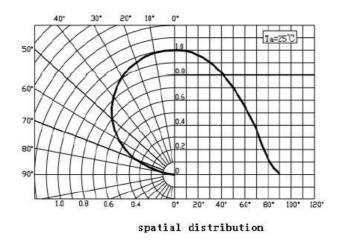








Typical Characteristic Curves - Radiation Pattern



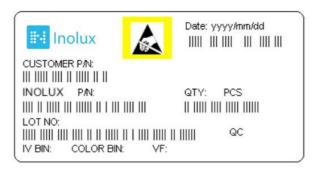
Ordering Information

Product	Emission Color	Test Current I _F (mA)	Luminous Intensity I _V (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
IN-S63DBS5R5UW	Red	5	30	1.9	IN-S63DBS5R5UW
IN-202D920D30VV	White	5	200	2.8	IN-202DG35H3UW

Bin Range specified on page 3.



Label Specifications



Inolux P/N:

I	N	1	S	6	3	D	В	S	5	R	5	U	W	-		
			Material	Pac	kage	Varia	ation	Orientation	Curren t	Color	Curren t	Lens	Color		tomize mp-off	
	olux MD		S = PCB Type	1.	6 x 0.8	DB = x 0.5m chip	ım	S = Side Mount	5= 5mA	R= 622nm	5= 5mA	U = Diffused	W= White			

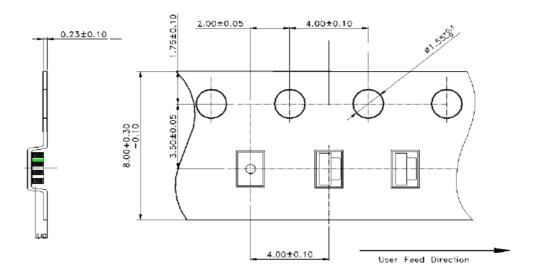
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	Month	Date	Serial		
Tracker		rear (2017)	, 2010,)	IVIOITLII	Date	Serial	

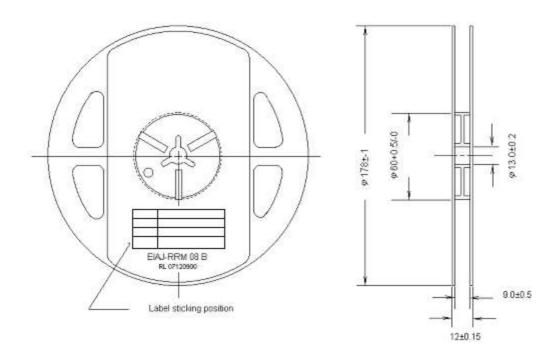


Packaging Information: 4000pcs Per Reel

Tape Dimension

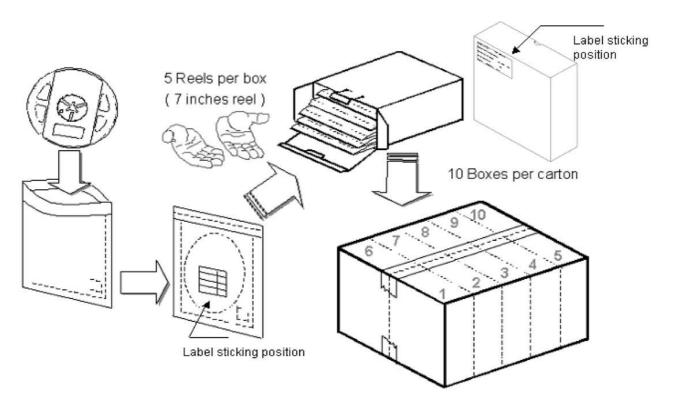


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Othous		·	

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

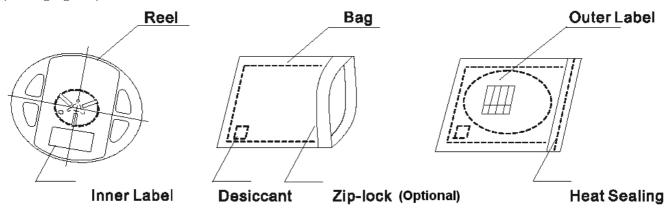


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

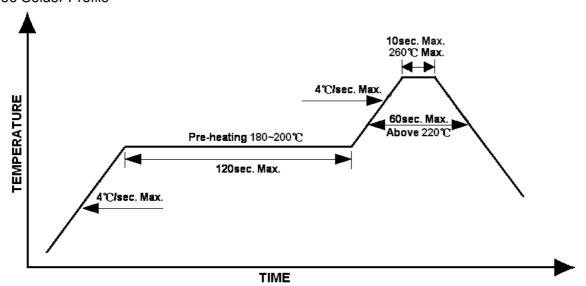
The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead-free Solder Profile





Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- · Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



IN-S63DBS5R5UW Side View SMD LED 0603 PCB Type

Reliability

Fliability	1	Τ=	T
Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μ s,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs



IN-S63DBS5R5UW Side View SMD LED 0603 PCB Type

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	04-15-2020
Updated	P1	V1.1	09-04-2020

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